



FEATURES

- Dual 1:10 fanout buffer/translator
- Accepts LVPECL or LVDS inputs
- Multiplexed inputs ideal for redundant clock switchover
- Guaranteed AC parameters:
 - > 2GHz f_{MAX} (toggle)
 - < 50ps ch-ch skew
- LVDS input includes 100Ω internal termination
- Low supply voltage: 2.5V, 3.3V
- -40°C to $+85^{\circ}\text{C}$ temperature range
- Output enable (OE) pin
- Available in 64 EPAD-TQFP



Precision Edge®

DESCRIPTION

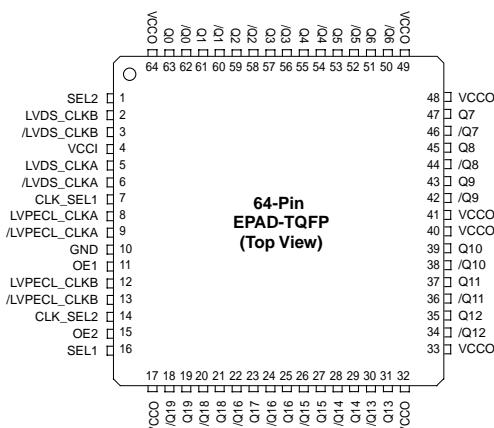
The SY89829U is a High Performance dual 1:10 or single 1:20 LVPECL Clock Driver. The part is designed for use in low voltage (2.5V/3.3V) applications which require a large number of outputs to drive precisely aligned, ultra low skew signals to their destination. The input is multiplexed from either LVDS or LVPECL by the CLK_SEL pin. The LVDS inputs include a 100Ω internal termination across the input pair, thus eliminating any need for external termination. The 2:1 input mux makes this device an ideal choice for redundant clock applications that need to switch between two reference clocks. The output enable (OE) is synchronous so that the outputs will only be enabled/disabled when they are already in the LOW state. This eliminates any chance of generating a runt clock pulse when the device is enabled/disabled as can happen with an asynchronous control.

The SY89829U features low pin-to-pin skew (50ps max.) and low part-to-part skew (200ps max.)—performance previously unachievable in a standard product having such a high number of outputs. The SY89829U is available in a single space saving package which provides a lower overall cost solution. In addition, a single chip solution improves timing budgets by eliminating the multiple device solution with their corresponding large part-to-part skew.

APPLICATIONS

- High-performance PCs
- Workstations
- Parallel processor-based systems
- Other high-performance computing
- Communications
- Redundant LVPECL or LVDS bus clock switchover

PACKAGE/ORDERING INFORMATION



64-Pin TQFP (H64-1)

Ordering Information⁽¹⁾

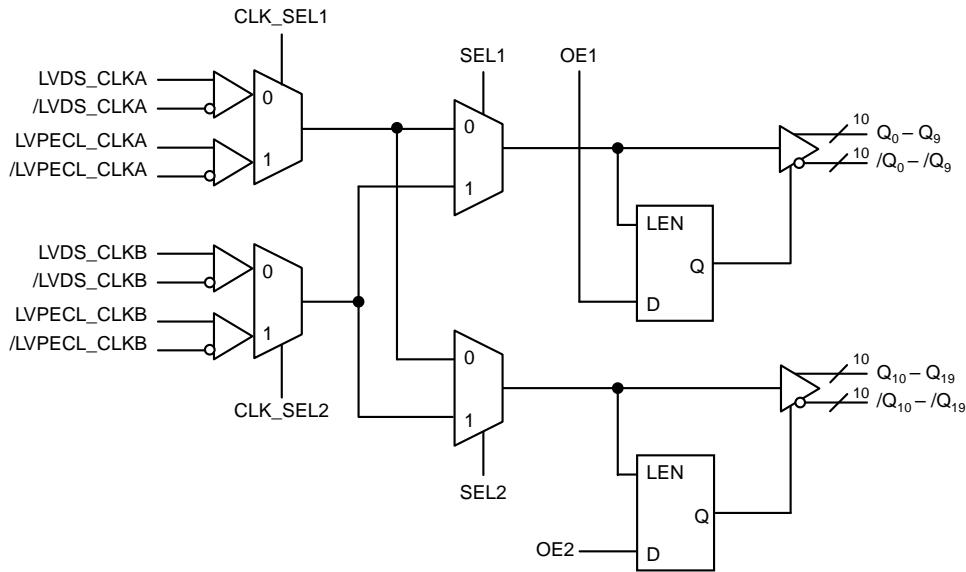
Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY89829UHI	H64-1	Industrial	SY89829UHI	Sn-Pb
SY89829UHTR ⁽²⁾	H64-1	Industrial	SY89829UHI	Sn-Pb
SY89829UHY ⁽³⁾	H64-1	Industrial	SY89829UHY with Pb-Free bar-line indicator	Pb-Free Matte-Sn
SY89829UHYTR ^(2, 3)	H64-1	Industrial	SY89829UHY with Pb-Free bar-line indicator	Pb-Free Matte-Sn

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC electricals only.
2. Tape and Reel.
3. Pb-Free package recommended for new designs.

PIN NAMES

Pin	Function
LVDS_CLKA, /LVDS_CLKA, LVDS_CLKB, /LVDS_CLKB	Differential LVDS Inputs with Internal 100Ω Termination.
LVPECL_CLKA, /LVPECL_CLKA LVPECL_CLKB, /LVPECL_CLKB	Differential LVPECL Inputs. For DC-coupled input signals, terminate the input signal with 50Ω to $V_{CC} - 2V$. For AC-coupled to $V_{CC} - 2V$. For AC-coupled terminate the input signal with 50Ω to $V_{CC} - 3V$.
CLK_SEL1, CLK_SEL2	Input CLK Select (LVTTL).
SEL1, SEL2	Input Select (LVTTL).
OE1, OE2	Output Enable (LVTTL).
$Q_0 - Q_{19}$, $/Q_0 - /Q_{19}$	Differential LVPECL Outputs. Normally terminated with 50Ω to $V_{CC} - 2V$. Unused output pairs can be left floating.
GND	Ground.
V_{CCI}	Power Supply for Output Drivers.

LOGIC SYMBOL**TRUTH TABLE**

OE	CLK_SEL1	CLK_SEL2	SEL1	SEL2	$Q_0 - Q_9$	$/Q_0 - /Q_9$	$Q_{10} - Q_{19}$	$/Q_{10} - /Q_{19}$
1	0	0	0	0	LVDS_CLKA	/LVDS_CLKA	LVDS_CLKA	/LVDS_CLKA
1	0	0	0	1	LVDS_CLKA	/LVDS_CLKA	LVDS_CLKB	/LVDS_CLKB
1	0	0	1	0	LVDS_CLKB	/LVDS_CLKB	LVDS_CLKA	/LVDS_CLKA
1	0	0	1	1	LVDS_CLKB	/LVDS_CLKB	LVDS_CLKB	/LVDS_CLKB
1	0	1	0	0	LVDS_CLKA	/LVDS_CLKA	LVDS_CLKA	/LVDS_CLKA
1	0	1	0	1	LVDS_CLKA	/LVDS_CLKA	LVPECL_CLKB	/LVPECL_CLKB
1	0	1	1	0	LVPECL_CLKB	/LVPECL_CLKB	LVDS_CLKA	/LVDS_CLKA
1	0	1	1	1	LVPECL_CLKB	/LVPECL_CLKB	LVPECL_CLKB	/LVPECL_CLKB
1	1	0	0	0	LVPECL_CLKA	/LVPECL_CLKA	LVPECL_CLKA	/LVPECL_CLKA
1	1	0	0	1	LVPECL_CLKA	/LVPECL_CLKA	LVDS_CLKB	/LVDS_CLKB
1	1	0	1	0	LVDS_CLKB	/LVDS_CLKB	LVPECL_CLKA	/LVPECL_CLKA
1	1	0	1	1	LVDS_CLKB	/LVDS_CLKB	LVDS_CLKB	/LVDS_CLKB
1	1	1	0	0	LVPECL_CLKA	/LVPECL_CLKA	LVPECL_CLKB	/LVPECL_CLKB
1	1	1	0	1	LVPECL_CLKA	/LVPECL_CLKA	LVPECL_CLKB	/LVPECL_CLKB
1	1	1	1	0	LVPECL_CLKB	/LVPECL_CLKB	LVPECL_CLKA	/LVPECL_CLKA
1	1	1	1	1	LVPECL_CLKB	/LVPECL_CLKB	LVPECL_CLKB	/LVPECL_CLKB
0	X	X	X	X	LOW	HIGH	LOW	HIGH

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Rating	Value	Unit
V_{CCI}/V_{CCO}	V_{CC} Pin Potential to Ground Pin	-0.5 to +4.0	V
V_{IN}	Input Voltage	-0.5 to V_{CCI}	V
I_{OUT}	DC Output Current (Output HIGH)	-50	mA
T_{LEAD}	Lead Temperature (soldering, 20sec.)	260	°C
T_{store}	Storage Temperature	-65 to +150	°C
θ_{JA}	Package Thermal Resistance (Junction-to-Ambient) <u>With exposed pad soldered to GND</u>	23 18 15	°C/W °C/W °C/W
	Exposed pad <u>not</u> soldered to GND	44 36 30	°C/W °C/W °C/W
θ_{JC}	Package Thermal Resistance (Junction-to-Case)	4.3	°C/W

NOTE:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data book. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

AC ELECTRICAL CHARACTERISTICS⁽¹⁾V_{CC} = 2.37V to 3.6V, GND = 0V

Symbol	Parameter	T _A = -40°C			T _A = +25°C			T _A = +85°C			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
f _{MAX}	Max Toggle Frequency ⁽²⁾	2	—	—	2	—	—	2	—	—	GHz
t _{PD}	Propagation Delay (Differential) ⁽³⁾	0.900 1.1	—	1.5 1.7	0.900 1.1	1.2	1.5	0.900 1.1	—	1.5 1.7	ns
t _{SKEW}	Within-Device Skew ⁽⁴⁾	—	—	35	—	20	35	—	—	35	ps
	Part-to-Part Skew ⁽⁵⁾	—	100	200	—	100	200	—	100	200	ps
t _{S(OE)}	OE Set-Up Time ⁽⁶⁾	1.0	—	—	1.0	—	—	1.0	—	—	ns
t _{H(OE)}	OE Hold Time ⁽⁶⁾	0.5	—	—	0.5	—	—	0.5	—	—	ns
t _r t _f	Output Rise/Fall Time (20% – 80%)	300	—	600	300	450	600	300	—	600	ps
t _(switchover)	Input Switchover CLK_SEL-to-valid output	—	—	1.2	—	—	1.2	—	—	1.2	ns

NOTES:

1. Outputs loaded with 50Ω to V_{CC} – 2V. Airflow ≥ 300lfpmin.
2. f_{MAX} is defined as the maximum toggle frequency measured. Measured with a 750mV input signal, all loading with 50Ω to V_{CC} – 2V.
3. Differential propagation delay is defined as the delay from the crossing point of the differential input signals to the crossing point of the differential output signals.
4. The within-device skew is defined as the worst case difference between any two similar delay paths within a single device operating at the same voltage and temperature.
5. The part-to-part skew is defined as the absolute worst case difference between any two delay paths on any two devices operating at the same voltage and temperature. Part-to-part skew is the total skew difference; pin-to-pin skew + part-to-part skew.
6. Set-up and hold time applies to synchronous applications that intend to enable/disable before the next clock cycle. For asynchronous applications, set-up and hold time does not apply. OE set-up time is defined with respect to the rising edge of the clock. OE HIGH to LOW transition ensures outputs remain disabled during the next clock cycle. OE LOW to HIGH transition enables normal operation of the next input clock.

LVDS/LVPECL INPUTS

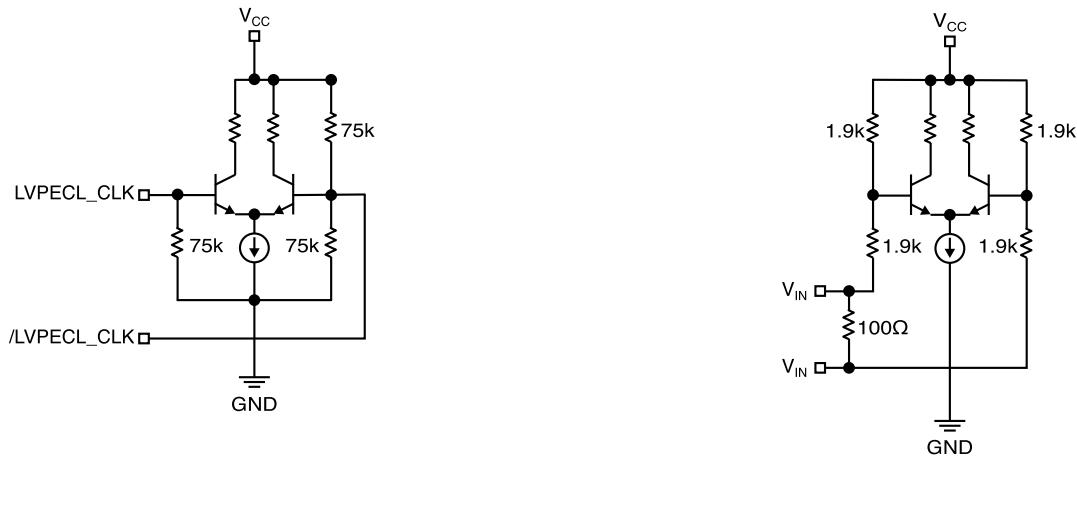
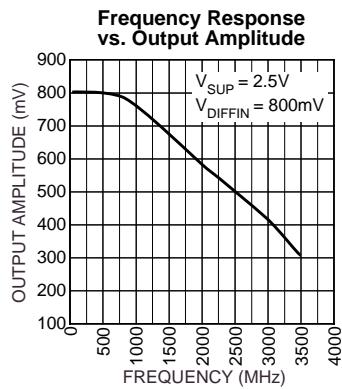
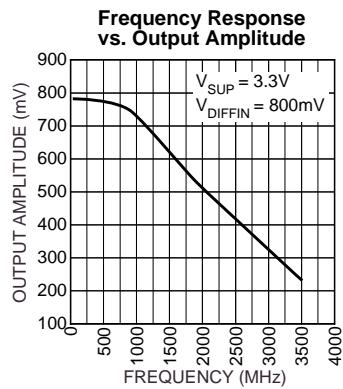


Figure 1. Simplified LVPECL & LVDS Input Stage

TYPICAL CHARACTERISTICS



Frequency Response
vs. Output Amplitude @ 2.5V



Frequency Response
vs. Output Amplitude @ 3.3V

LVPECL TERMINATION RECOMMENDATIONS

Output Considerations

Be sure to properly terminate all outputs as shown below, or equivalent. For AC coupled applications, be sure to include a pull

down resistor at the output of each driver. The emitter follower outputs requires a DC current path to GND. Unused outputs can be left floating with minimal impact on skew and jitter.

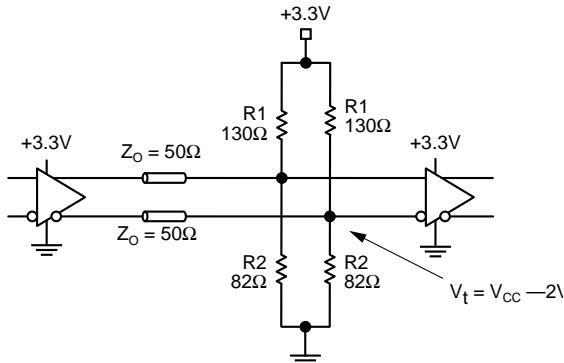


Figure 1. Parallel Termination—Thevenin Equivalent

Notes:

1. For +2.5V systems:

$$R1 = 250\Omega$$

$$R2 = 62.5\Omega$$

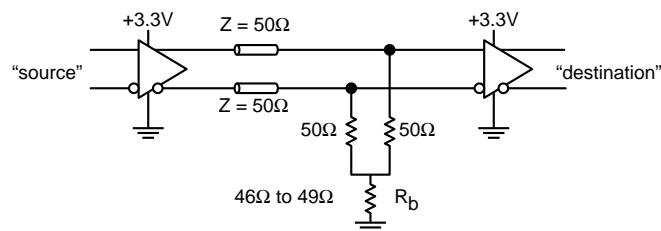
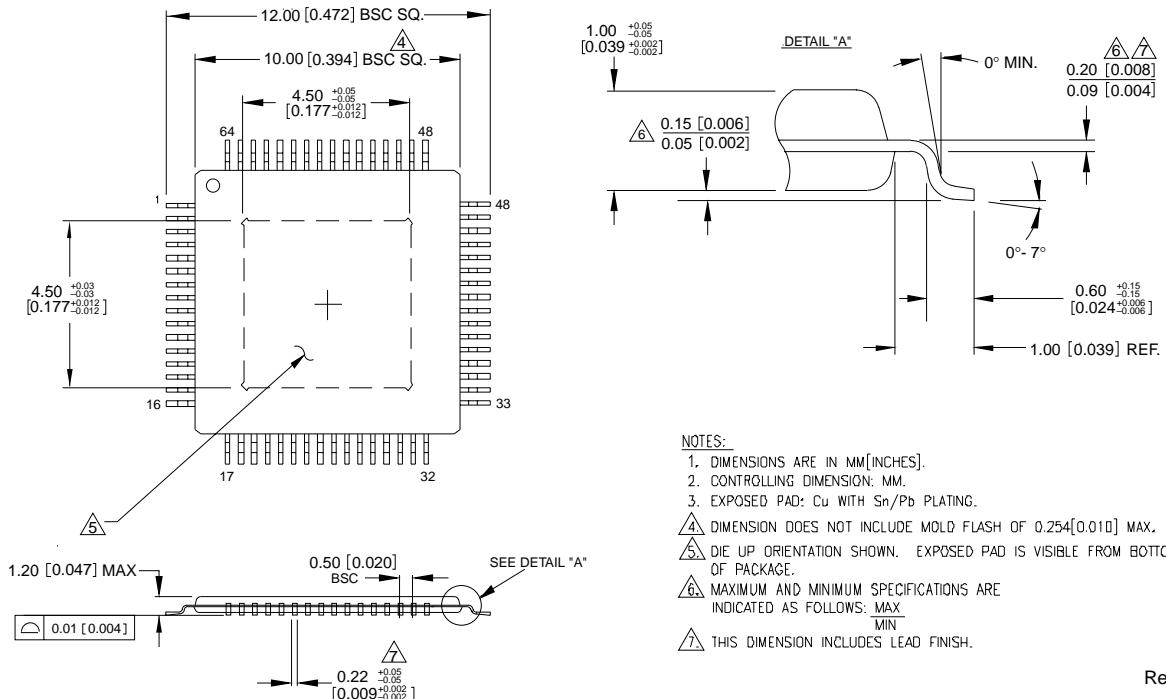


Figure 2. Three-Resistor "Y-Termination"

Notes:

1. Power-saving alternative to Thevenin termination.
2. Place termination resistors as close to destination inputs as possible.
3. R_b resistor sets the DC bias voltage equal to V_t . For +3.3V systems $R_b = 46\Omega$ to 50Ω .
4. Precision, low-cost 3-Resistor networks are available from resistor manufacturers such as Thin Film Technology (www.thinfilm.com).

64-PIN EPAD-TQFP (DIE UP) (H64-1)



Rev. 03

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